



YEA SHIN TECHNOLOGY CO., LTD

YSE2120AYVB

N+P-Channel Enhancement MOSFET

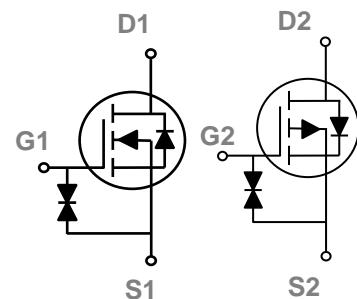
N-ch: VDS= 20V, ID= 0.8A / P-ch: VDS= -20V, ID= -0.4A



Features

- *Fast switching*
- *Green Device Available*
- *Suit for 1.5V Gate Drive Applications*

SOT-563 Dual Pin Configuration



Applications

- *Notebook*
- *Load Switch*
- *Networking*
- *Hand-held Instruments*

Absolute Maximum Rating $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
V_{DS}	Drain-Source Voltage	20	-20	V
V_{GS}	Gate-Source Voltage	± 12	± 12	V
I_D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	0.8	-0.4	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	0.51	-0.25	A
I_{DM}	Drain Current – Pulsed ¹	3.2	-1.6	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	0.312	0.312	W
	Power Dissipation – Derate above 25°C	2.5	2.5	mW/C
T_{STG}	Storage Temperature Range	-55 to 150	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	400	°C / W

DEVICE CHARACTERISTICS

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N-CH Electrical Characteristics (T_J=25°C, unless otherwise)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	20	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C, I _D =1mA	---	-0.01	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =20V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =16V, V _{GS} =0V, T _J =125°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±8V, V _{DS} =0V	---	---	±20	uA

On Characteristics

R _{DSON}	Static Drain-source On-Resistance	V _{GS} =4.5V, I _D =0.5A	---	200	300	mΩ
		V _{GS} =2.5V, I _D =0.4A	---	235	400	mΩ
		V _{GS} =1.8V, I _D =0.2A	---	295	550	mΩ
		V _{GS} =1.5V, I _D =0.1A	---	365	800	mΩ
		V _{GS} =1.2V, I _D =0.1A	---	600	---	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	0.3	0.6	1	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	3	---	mV/°C

Dynamic and Switching Characteristics

Q _g	Total Gate Charge ^{2,3}	V _{DS} =10V, V _{GS} =4.5V, I _D =0.5A	---	1	2	nC
Q _{gs}	Gate-Source Charge ^{2,3}		---	0.26	0.5	
Q _{gd}	Gate-Drain Charge ^{2,3}		---	0.2	0.4	
T _{d(on)}	Turn-On Delay Time ^{2,3}	V _{DD} =10V, V _{GS} =4.5V, R _G =10 Ω , I _D =0.5A	---	5	10	ns
T _r	Rise Time ^{2,3}		---	3.5	7	
T _{d(off)}	Turn-On Delay Time ^{2,3}		---	14	28	
T _f	Fall Time ^{2,3}		---	6	12	
C _{iss}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=1MHz	---	38.2	75	pF
C _{oss}	Output Capacitance		---	14.4	28	
C _{rss}	Reverse Transfer Capacitance		---	6	12	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	0.8	A
I _{SM}	Pulsed Source Current		---	---	1.6	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _s =0.2A, T _J =25°C	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

DEVICE CHARACTERISTICS

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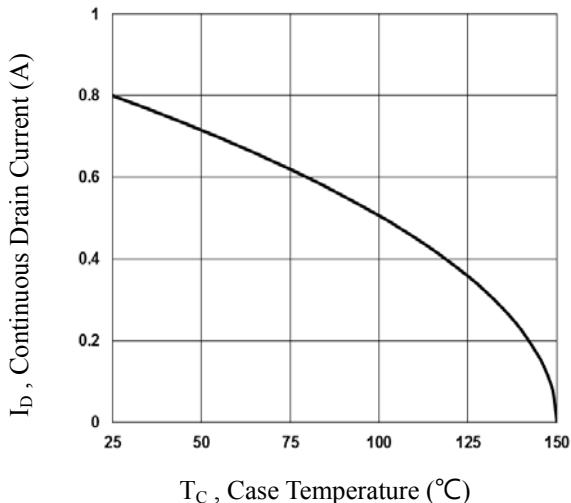


Fig.1 Continuous Drain Current vs. T_C

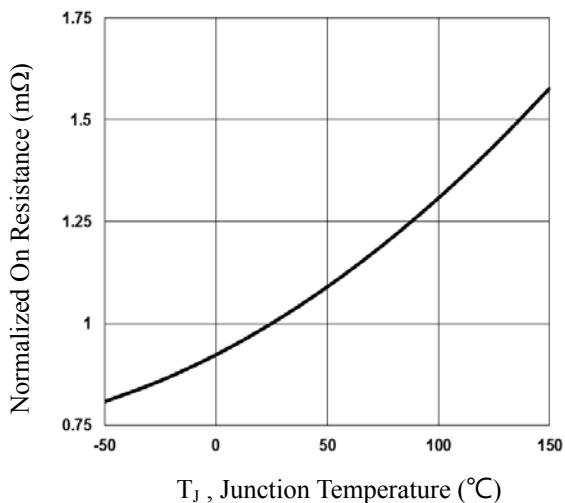


Fig.2 Normalized RDSON vs. T_J

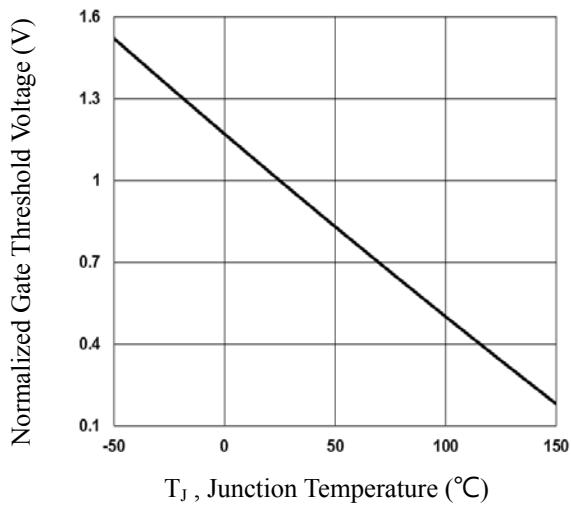


Fig.3 Normalized V_{th} vs. T_J

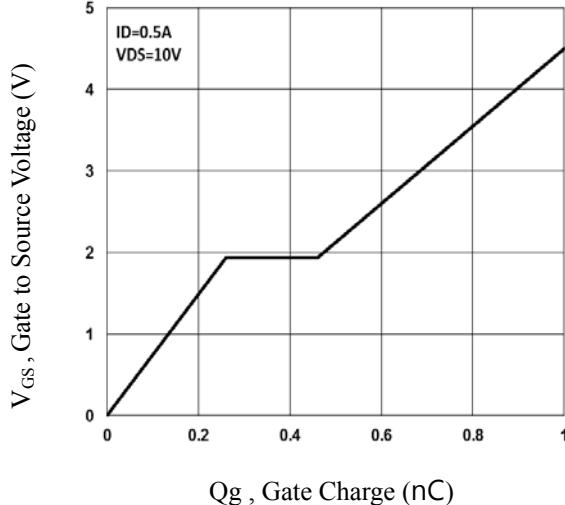


Fig.4 Gate Charge Waveform

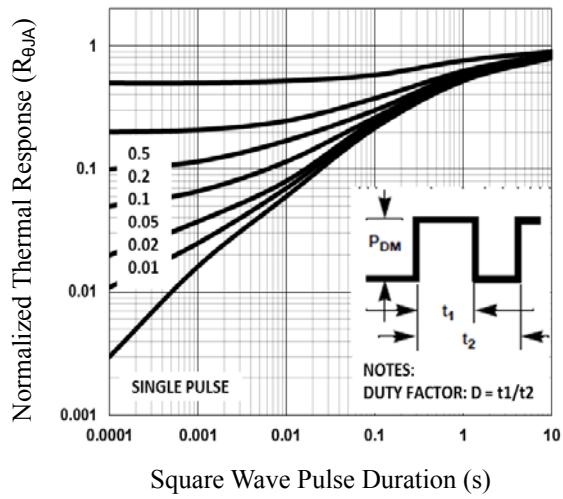


Fig.5 Normalized Transient Impedance

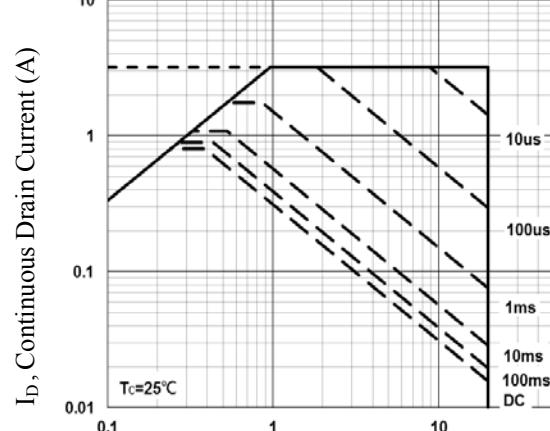


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

YSE2120AYVB

P-CH Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=-1\text{mA}$	---	-0.01	---	$\text{V}/^\circ\text{C}$
I_{DSs}	Drain-Source Leakage Current	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{DS}}=-16\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GSs}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 8\text{V}, V_{\text{DS}}=0\text{V}$	---	---	± 20	μA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-source On-Resistance	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-0.3\text{A}$	---	440	600	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-0.2\text{A}$	---	610	850	$\text{m}\Omega$
		$V_{\text{GS}}=-1.8\text{V}, I_{\text{D}}=-0.1\text{A}$	---	810	1200	$\text{m}\Omega$
		$V_{\text{GS}}=-1.5\text{V}, I_{\text{D}}=-0.1\text{A}$	---	1020	1600	$\text{m}\Omega$
		$V_{\text{GS}}=-1.2\text{V}, I_{\text{D}}=-0.1\text{A}$	---	1800	---	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=-250\mu\text{A}$	-0.3	-0.6	-1	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	3	---	$\text{mV}/^\circ\text{C}$

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-0.2\text{A}$	---	1	2	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	0.28	0.5	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	0.18	0.4	
$T_{d(on)}$	Turn-On Delay Time ^{2,3}	$V_{\text{DD}}=-10\text{V}, V_{\text{GS}}=-4.5\text{V}, R_{\text{G}}=10\Omega, I_{\text{D}}=-0.2\text{A}$	---	8	16	ns
T_r	Rise Time ^{2,3}		---	5.2	10	
$T_{d(off)}$	Turn-On Delay Time ^{2,3}		---	30	60	
T_f	Fall Time ^{2,3}		---	18	36	
C_{iss}	Input Capacitance	$V_{\text{DS}}=-10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	40	78	pF
C_{oss}	Output Capacitance		---	15	30	
C_{rss}	Reverse Transfer Capacitance		---	6.5	13	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-0.4	A
I_{sm}	Pulsed Source Current		---	---	-0.8	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-0.2\text{A}, T_J=25^\circ\text{C}$	---	---	-1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

DEVICE CHARACTERISTICS

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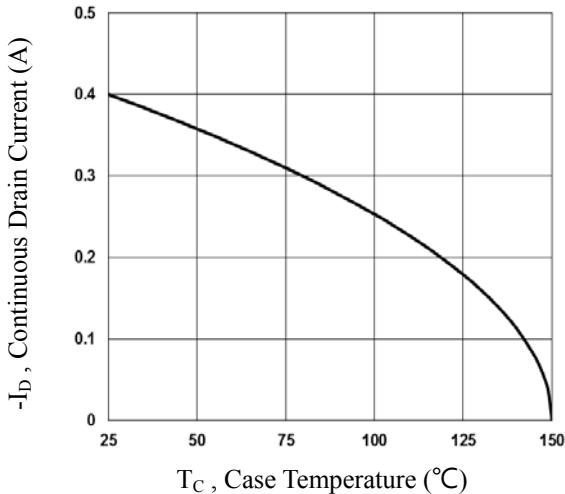


Fig.7 Continuous Drain Current vs. T_C

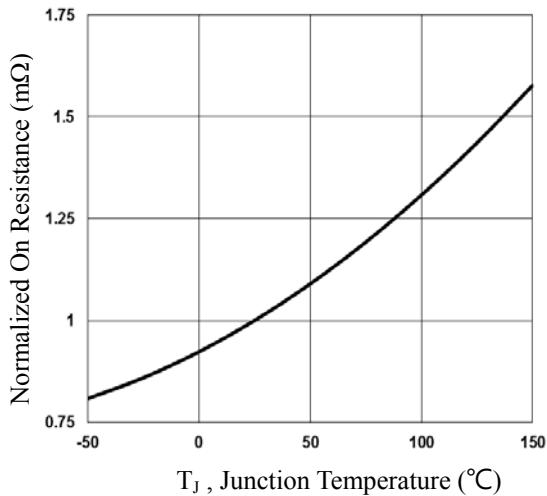


Fig.8 Normalized RD_{SON} vs. T_J

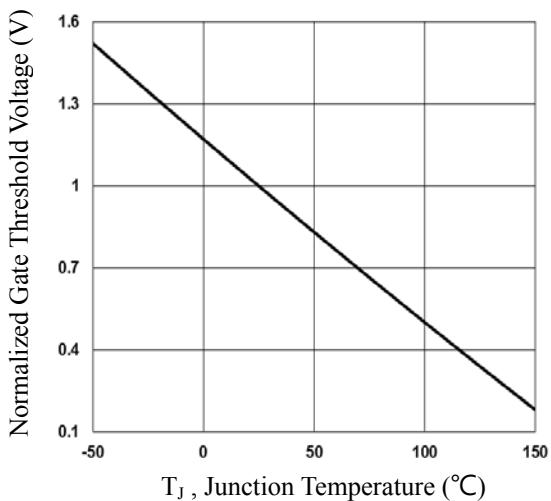


Fig.9 Normalized V_{th} vs. T_J

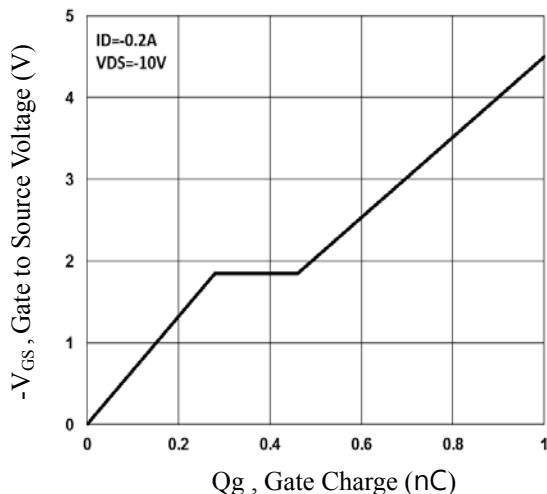


Fig.10 Gate Charge Waveform

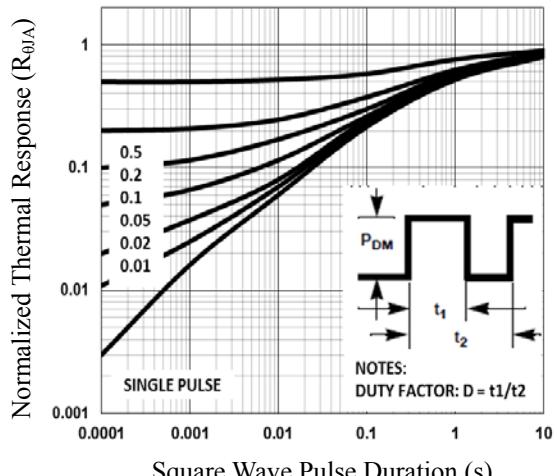


Fig.11 Normalized Transient Impedance

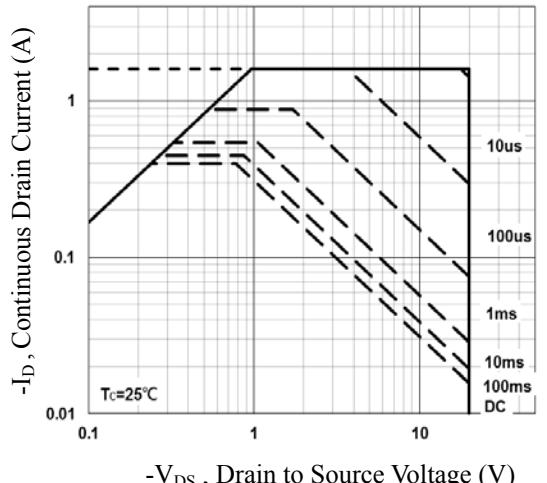
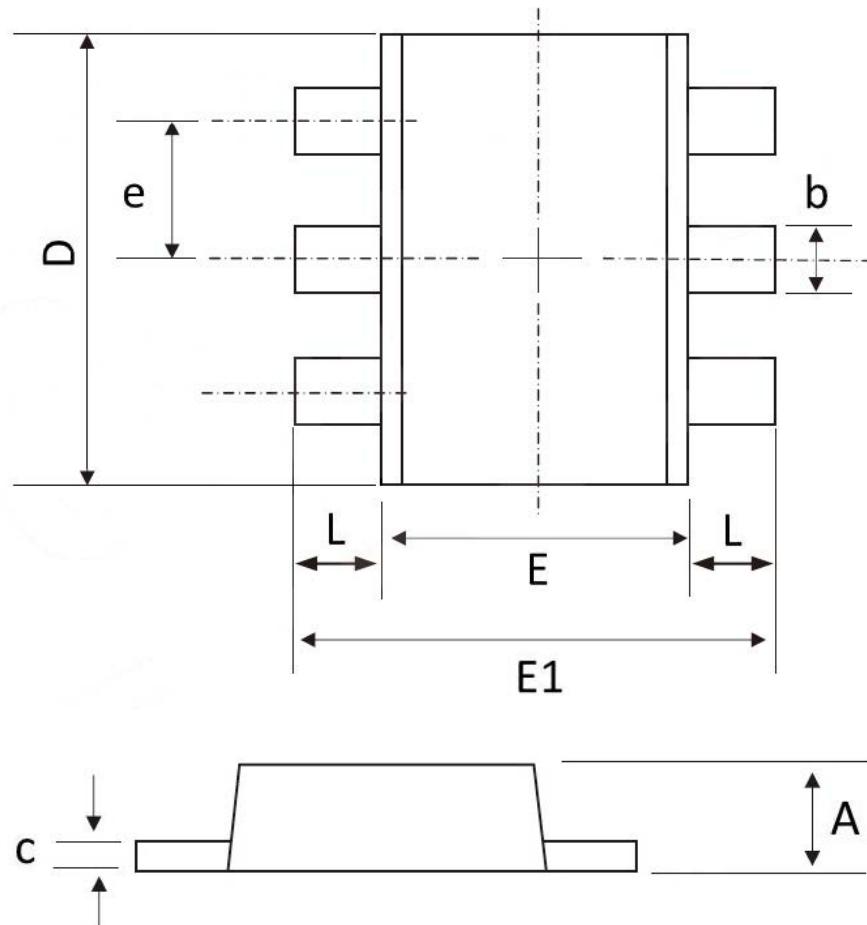


Fig.12 Maximum Safe Operation Area

PACKAGE OUTLINE & DIMENSIONS

YSE2120AYVB

SOT-563 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	0.600	0.500	0.024	0.020
b	0.300	0.150	0.012	0.006
c	0.180	0.100	0.007	0.004
D	1.700	1.500	0.067	0.059
E	1.250	1.100	0.049	0.043
E1	1.700	1.550	0.067	0.061
e	0.5BSC		0.02BSC	
L	0.300	0.100	0.012	0.004